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Abstract

Electronic component having an integrated passive electronic component and method for producing it

An electronic component (EB) has a first insulation layer (1), on which a first metal layer (5) is arranged. An electrically conductive structure (2) is integrated into the first insulation layer (1), mechanically stabilizes the first insulation layer (1) during bonding and/or mounting of the component (EB) and is formed as a passive electronic component.

(Figure 1)